

To: _____

Change Notification
Photocoupler (Quantity of Inner Carton)

We appreciate your patronage of our semiconductor products.

Change is planned for our photocoupler.

Please refer to the following contents. We would appreciate your understanding.

1. Applicable product: (including special specification product)

- DIP4, DIP6, DIP8, SDIP6 type: All the product that is packed in tape.
- Other products packed in tape have been announced by Issue No. BBHKN-16-00083.
- * The products manufactured by Toshiba Semiconductor Thailand Co.,Ltd. (TST) are included.

2. Change description: The packing specification of the above products is changed as follows.

No.	Changes	Before change	After change
1)	Quantity of inner carton	10 inner cartons	5 inner cartons
2)	Outer carton		

3. Purpose of change

- The purpose of the change is to reduce a damage during transportation, such as vibration.
- * The risk of deformation on embossed tape and product lead pin (that is caused by vibration) will be reduced

4. Product characteristics

- The quantity of inner carton (packed in an outer carton) and the size of outer carton are changed. Since there is no change in product structure or process, the initial characteristics and reliability level are same as the existing products.

5. Change schedule

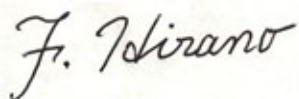
- The change will be implemented in order, from the production of September 2019.
- * The above schedule is applied to the products announced in BBHKN-16-00083, as well.

6. Request

If you have any inconvenience on this change, please inform us through our sales representatives by August 23, 2019.

If we have not heard from you by the above date, we will change the packing in order, assuming that you have agreed to our proposal.

Sincerely yours,



F. Hirano / Manager
Quality Planning Group
Quality Assurance Department
Buzen Toshiba Electronics Corporation

(Drafted by T. Uchino)